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	1.02		Kanda Surugadai, 4-chome, Chiyoda-ku, okyo, Japan
Additional name(s) of conveying party(ies) at	ttached? ☐ Yes ☒ No		
Nature of conveyance:			
Security Agreement	Merger Change of Name		
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Execution Date: March 4, 2002			
Application number(s) or patent number(s If this document is being filed together wit A. Patent Application No.(s)	· · ·	ecution date of the ap B. Patent Registration	•
10/083,255 Filed February :	27, 2002		
	ľ		
	Additional number(s) attac	thed ☐ Yes ☒ No	
Name and address of party to whom corr concerning document should be mailed:	respondence		ations and patents involved 1
Name: Antonelli, Terry, Stout & Kra	aus, LLP	7. Total fee (37 CFR :	3.41) \$40.00
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9. Statement and signature. To the best of my knowledge and becopy of the original document.	lief, the foregoing inform	nation is true and co	rrect and any attached copy is a true
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Total number of pages including cover sheet, attachments, and document: 2

PATENT REEL: 012856 FRAME: 0765

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI, LTD., a corporation organized under the laws of Japan, located at 6, Kanda Surugadai 4-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI, LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

SEMICONDUCTOR PROCESSING APPARATUS AND WAFER SENSOR MODULE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI, LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI, LTD.

Signed on the date(s) indicated aside signatures:

INVENTOR(S)

	(発明者フルネームサイン)	(署名日)
1)	Ryujiro Udo Ryujiro UDO	Mar. 4. 2002
2)	Ryujiro UDO <u>Masatsugu Avav</u> Masatsugu ARAI	May. 4.2002
3)	Masatsugu ARAI Manabu Edamura	Mar. 4.2002 Mar. 4.2002
	Manabu EDAMURA	
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PATENT REEL: 012856 FRAME: 0766

Date Signed

RECORDED: 05/02/2002